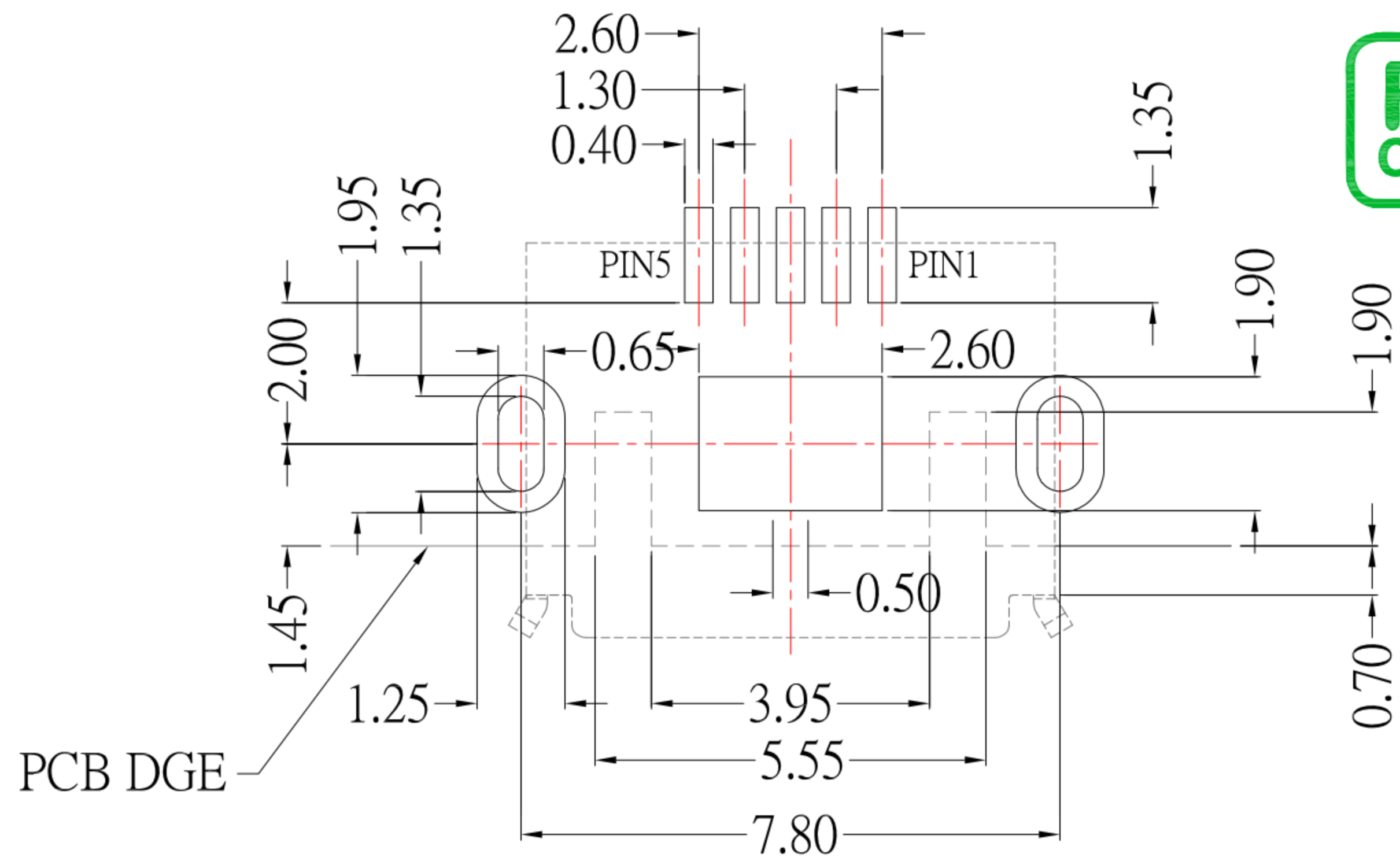
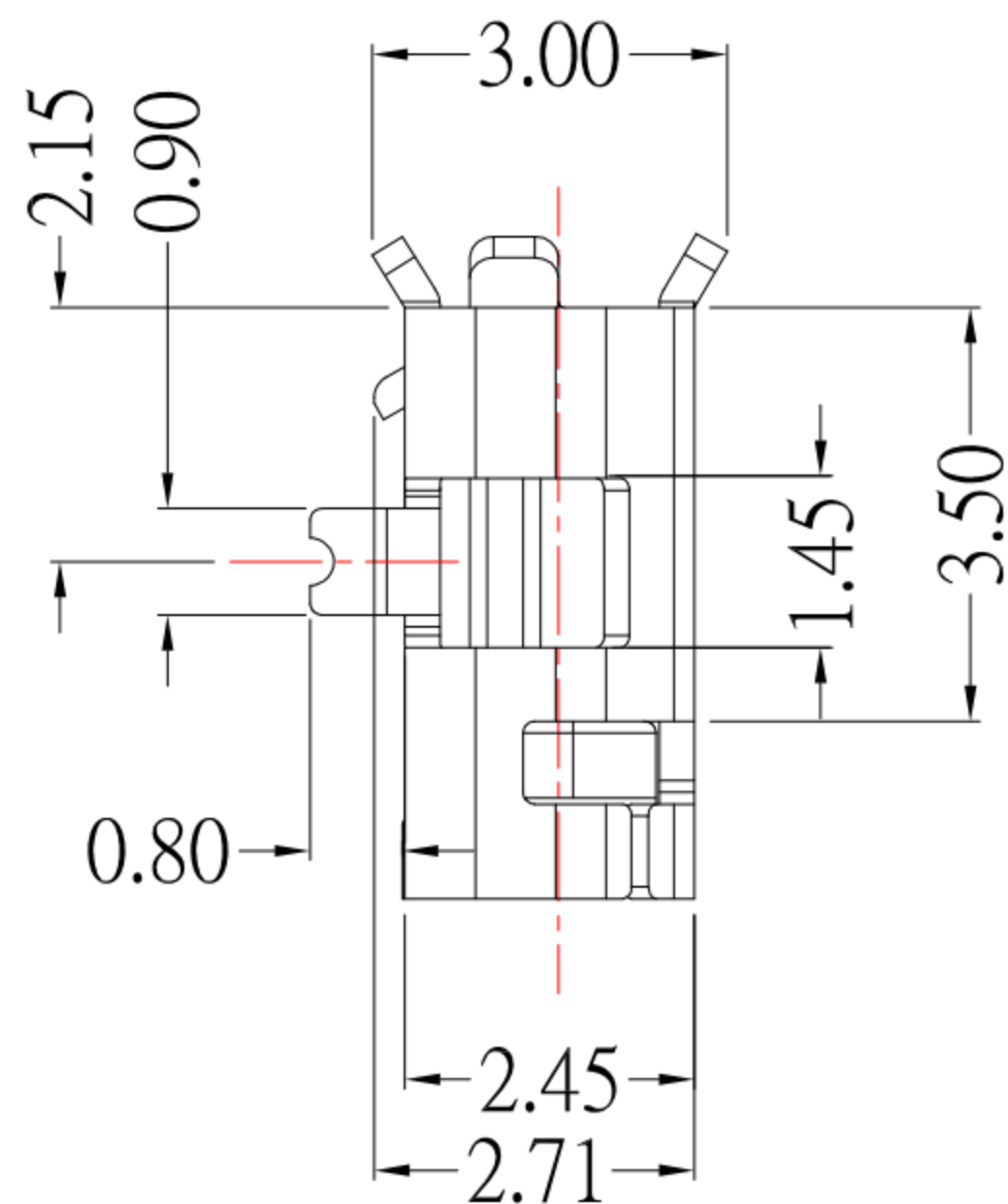
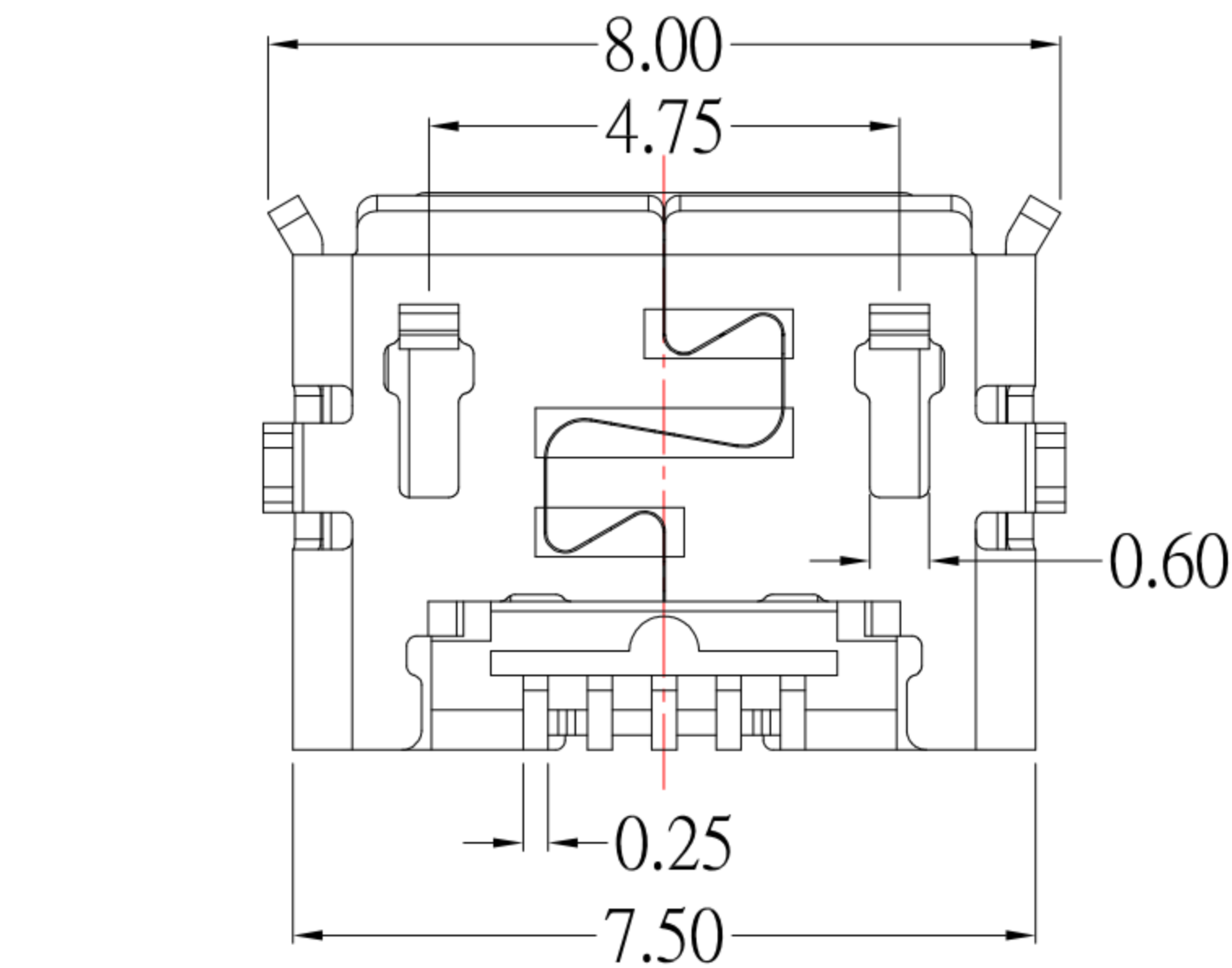
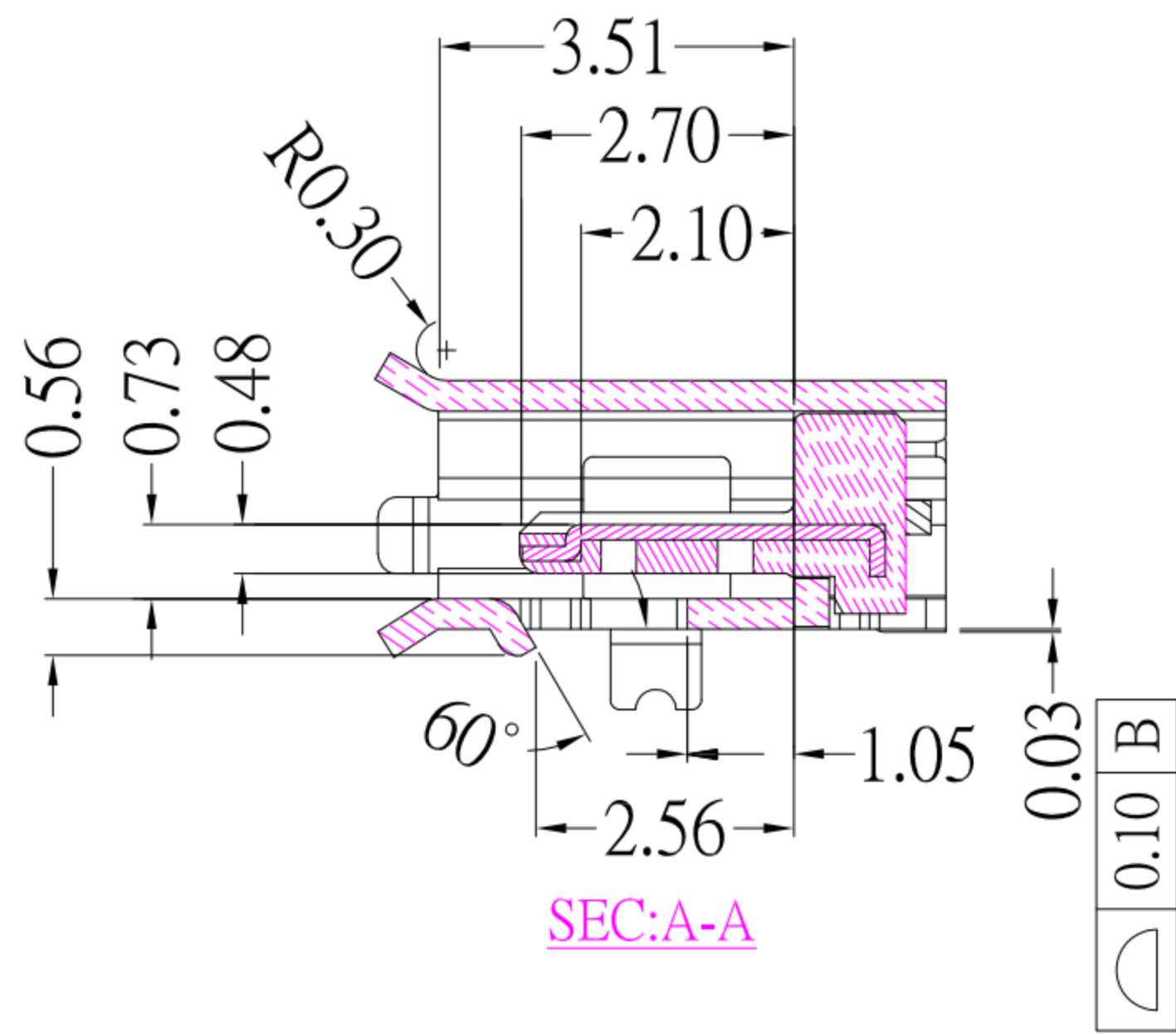
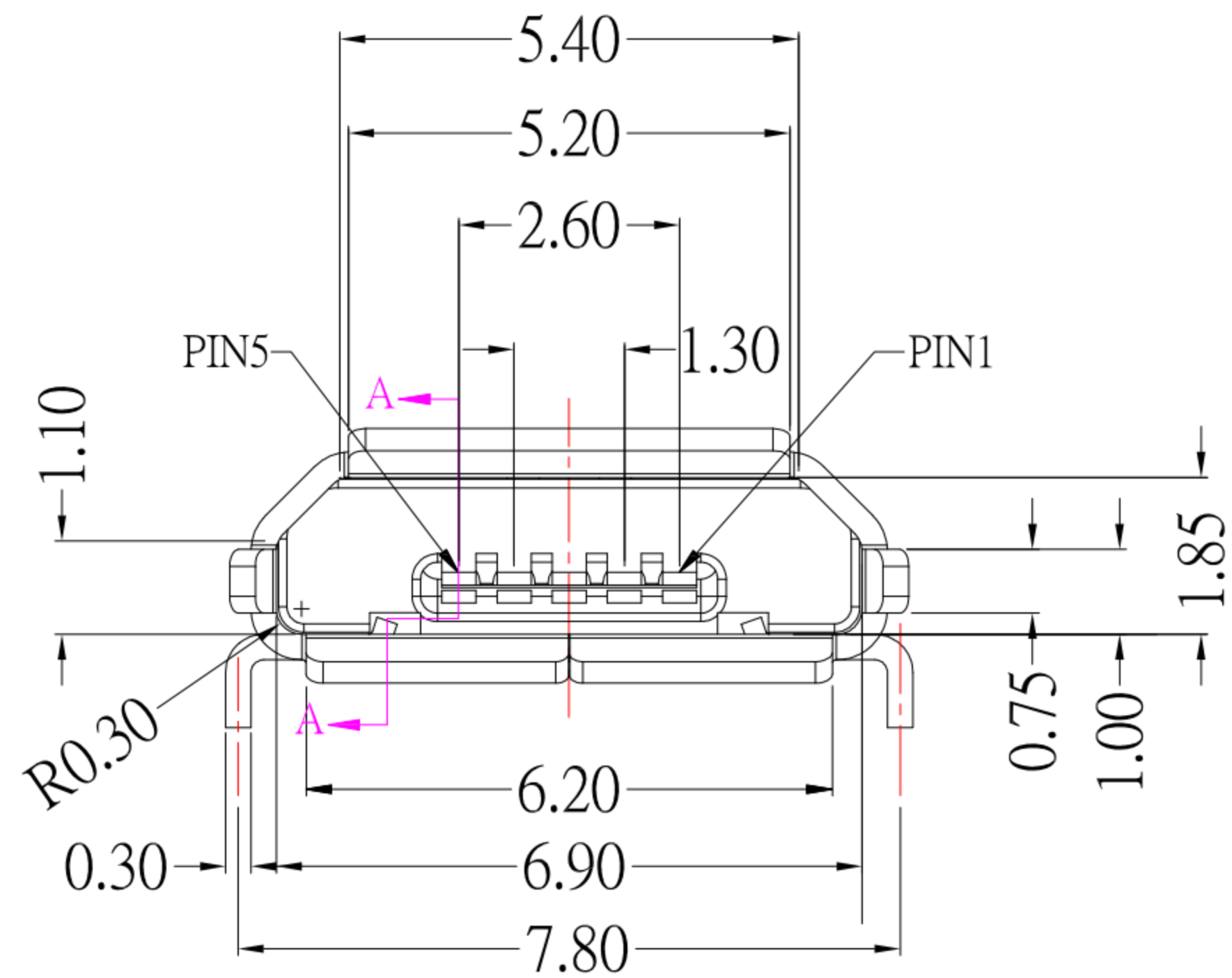
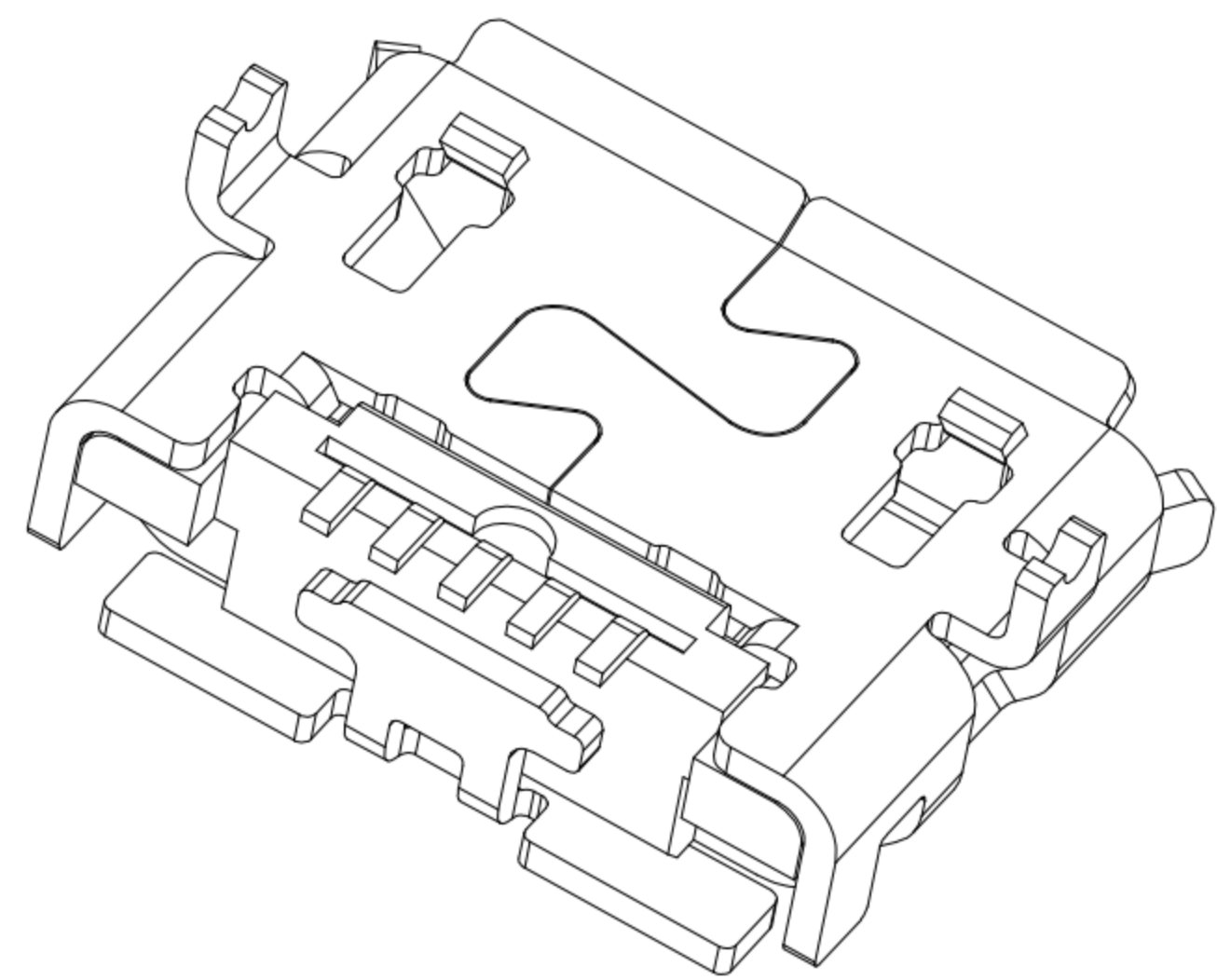
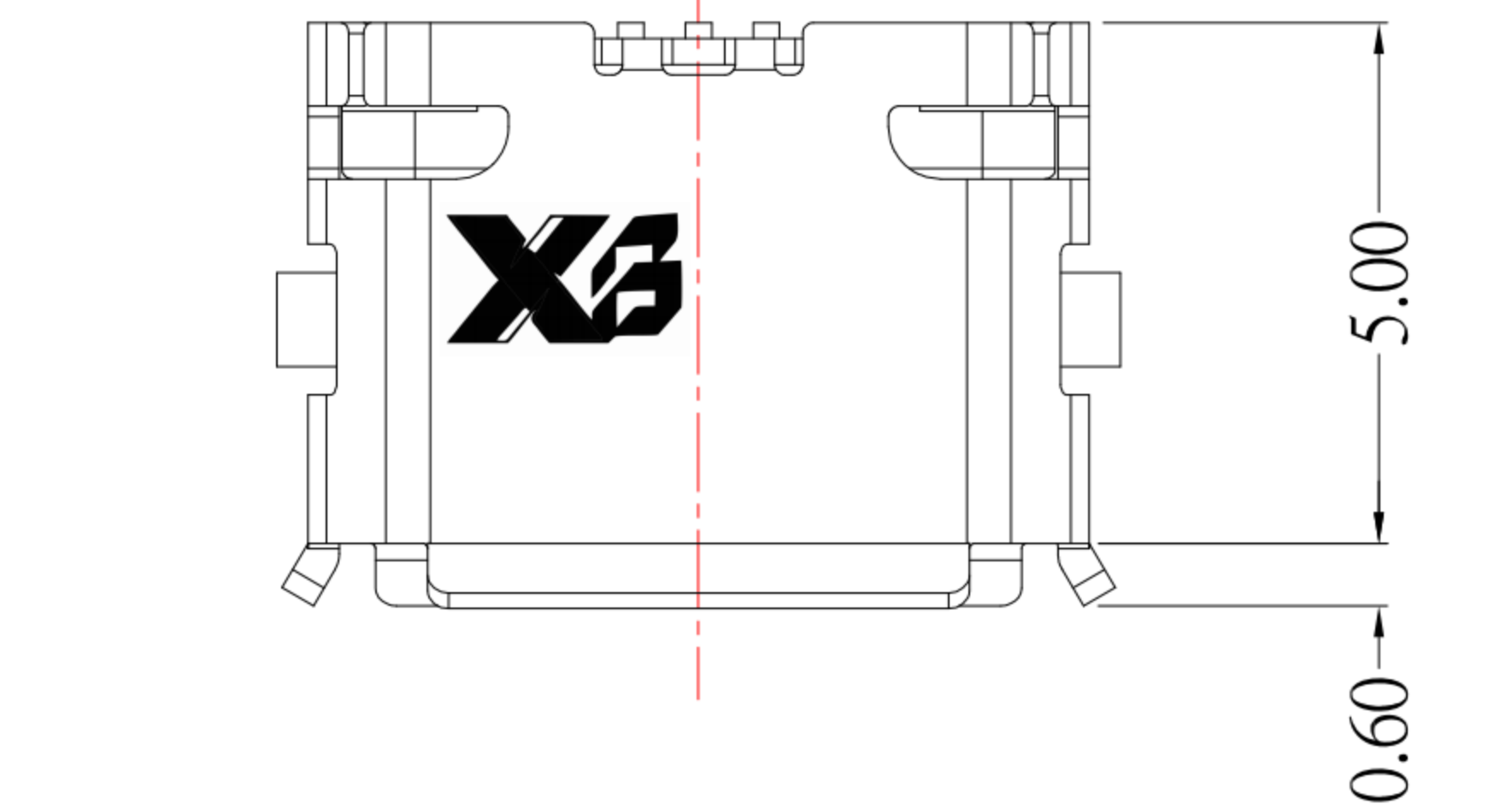




PCB LAYOUT MOUNTING PATTERN

MRUSB-5B-RV1x-S183

外殼鍍層:

Blank: Tin

NI : Ni

SPECIFICATIONS

Electrical:

1.Current Rating: 1.8A(1&5PIN)
0.5A(2&3&4PIN)

2.Contact Resistance: 60 mΩ Max

3.Dielectric Withstanding Voltage:
100 V AC / 1 minute

4.Insulation Resistance:
100 MΩ Min @ 500 VDC

Mechanical:

1.Connector Mate and Unmate Force
Mate force: 3.57 kgf Max
Unmate force: 0.816 kgf Min

2.Durability: 10,000 cycles Min

3.Contact retention force: 0.214 kgf Min

Material:

1.Housing:
High Temperature Thermal Plastics,
UL 94V-0 , LCP , Black

2.Contact: Phosphor Bronze

3.Shell: Stainless Steel

Finish:

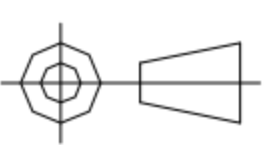
1.Contact: Gold plated on the contact area
and Nickel under plated overall.

2.Shell: Tin under Plated surface layer
or Nickel under Plated surface layer



TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:

Jack Lu

DATE

06/12/14

MAT'L

CHECKED BY:

Jacky Chen

DATE

06/12/14

FINISH

APPROVED BY:

Tony Kao

DATE

06/12/14

SCALE

1 : 1

SHEET NO.

1 of 1

TITLE

MODLE

DWG NO.

PART NO.

CONNECTOR

MICRO USB B TYPE REVERSE
SHELLED DIP

MRUSB-5B-RV1x-S183

MRUSB-5B-RV1x-S183

SIZE

A4

VER

R3